Appl. No. 10/602,336   PATENT
Amdt. dated August 23, 2004
Reply to Office Action of May 25, 2004

Amendments to the Claims:

This listing of claims will replace all prior versions, and listings of claims in the application:

Listing of Claims:

Claims 1.-14. (Canceled)

Claim 15. (New) A method comprising:

    (a)   providing a leadframe comprising (i) a source pad, (ii) at least two source lead rails at a periphery of the source pad, and (iii) a gate pad adjacent the source pad and electrically isolated therefrom; and (iv) a gate lead rail at a periphery of the gate pad;

    (b)   attaching a die to the leadframe, wherein the die is coupled to the source pad and the gate pad; and

    (c)   attaching a stiffener to the leadframe, wherein the stiffener is electrically isolated therefrom.

Claim 16. (New) The method of claim 15 wherein the stiffener comprises a copper slug.

Claim 17. (New) The method of claim 15 wherein the stiffener is coupled to the leadframe with polyimide tape that provides the electrical isolation.

Claim 18. (New) The method of claim 17 wherein the stiffener comprises a copper slug.

Claim 19. (New) The method of claim 17 wherein the leadframe comprises at least three source lead rails.

Claim 20. (New) A method comprising:

    (a)   providing a leadframe including a top and a bottom surface, and gate and source leads;

    (b)   attaching a die to the bottom surface such that a surface of the die is coplanar with the gate and source leads; and

(c)   attaching a stiffener to the top surface, wherein the stiffener is electrically isolated from the top surface of the leadframe.

Claim 21. (New) The method of claim 20 wherein the stiffener is coupled to the leadframe with polyimide tape that provides the electrical isolation.

Claim 22. (New) The method of claim 20 wherein the stiffener comprises a copper slug.

Claim 23. (New) The method of claim 15 wherein (b) is performed after (c).

Claim 24. (New) The method of claim 20 wherein (b) is performed after (c).